## Message from the Editor-in-Chief

## HIDETOSHI ONODERA<sup>†1</sup>

On behalf of the editorial board, I am pleased to present the fourth volume of the IPSJ Transactions on System LSI Design Methodology (TSLDM). TSLDM aims to provide the best opportunity for all researchers working on the design, the electronic design automation, and the design methodologies of a system LSI (System-on-Chip) to publish their work and learn about state-of-the-art achievements in these and other related fields.

TSLDM is currently on a bi-annual schedule. This year, similar to the previous year, the fourth volume is going to contain the February and August issues.

TSLDM is unique in providing an open-access on-line publication so that authors can efficiently disseminate their important achievements to the widest R&D community of the world. Papers can be browsed and downloaded worldwide through the internet free of charge without any restrictions. Another important feature of TSLDM is its timely and rapid publication. We do not have a back-log problem. Every issue has a predetermined editorial schedule announced in the call for papers. Authors can therefore expect the date of publication to be just nine months after the submission is due. This makes it more attractive to submit and publish up-to-date information on research and development.

TSLDM, successfully launched in August 2008, has been quickly establishing itself as one of the representative journals in our research community. I have been serving as the Editor-in-Chief from the first volume, and this is the last volume that goes out under my editorship. I would like to take this opportunity to thank all the members of the editorial board and the reviewers for their commitment and efforts in making TSLDM a high-quality journal. I especially recognize and thank the three editors, Profs. Hiroyuki Tomiyama, Hiroyuki Ochi and Tohru Ishihara,

for their excellent management of the editorial process. I believe the new Editorin-Chief, Prof. Hiroyuki Tomiyama, will further enhance the penetration of the journal in its core and related scientific and technological communities. I am sure that TSLDM will continue to offer an ideal forum for the exchange of ideas about the challenges and solutions for the future.

Last, but not least, I would like to thank all the authors who submitted papers with valuable results, since their contributions form the basis of our technical excellence.

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